

AKAFLEX® PEICL HT:

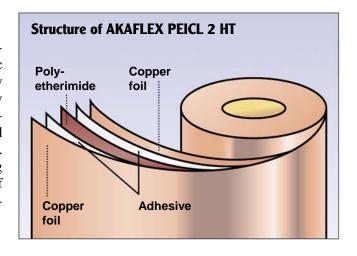
Copper laminates on a polyetherimide-film backing for flexible printed circuits

The AKAFLEX® PEICL HT programme

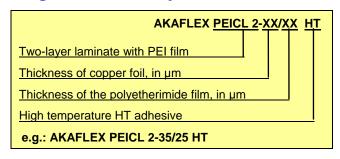
AKAFLEX PEICL HT is available from KREMPEL as

- √ two-layer laminates and
- **✓** three-layer laminates.

Polyetherimide film (PEI) is used as the backing material for the copper. This is laminated with electrolytic (ED) copper foil on one or both sides. A modified epoxy system characterised by very good temperature stability has been developed for the HT product family. In combination with polyimide film, the bonding system used here reaches a temperature index per UL 796 of 150 °C. AKAFLEX PEICL HT is **halogen-free.** The bonding system with polyimide film meets the requirements of **UL 94V-0** for **flame retardance**. The PEI film is classified in **VTM-0**.



Designation for a two-layer laminate



Standard types of AKAFLEX® PEICL HT

Standard type designation	Thickness of copper foil	Thickness of polyetherimide film				
Two-layer laminates						
PEICL 2-35/25 HT*	35 µm	25 µm				
PEICL 2-35/50 HT	35 µm	50 μm				

*Data being developed



7.3.1

All values stated are to be seen as typical values. We reserve the right to introduce changes within the framework of further technical development. We do not accept any obligations or liabilities in respect of this information. Status: 06/2007 August Krempel Soehne GmbH+Co. KG · P.O.Box 1240 · D-71655 Vaihingen · Tel. (+49) 7042 915-0 · e-mail: info@krempel.com



Processing AKAFLEX® PEICL HT

AKAFLEX PEICL HT can be processed **»reel to reel**« by screen-printing or photolithography and the standard etching and cleaning techniques. The technical advantages in manufacturing are assured in this way.

A comprehensive range of **coverlays** for **mechanical protection** of the etched circuits is available from KREMPEL. Diverse **bonding films** are also available for manufacturing **multilayer** circuits.

We use modified **epoxy-resin adhesives** only. This means that no special plasma treatment is necessary in the manufacture of flexible multilayer circuits.



Certified according to ISO 9001 and ISO/TS 16949

Quality assurance

All AKAFLEX products are subject to the procedures of on-going quality control as defined in the Quality Assurance Handbook of August Krempel Soehne. This quality assurance system is certified as meeting the requirements of ISO 9001 and ISO/TS 16949. For AKAFLEX PEICL HT, testing is performed on the master reels according to the methods of IPC-TM 650.

Availability of AKAFLEX® PEICL HT

✓ Standard reel width:

610 mm or 305 mm; other widths on request

✓ Standard reel length:

150 m;

other lengths on request

✓ Format:

As requested by the customer

✓ Packaging:

Reels suspended in robust corrugated-cardboard cartons

✓ Standard cores:

Inside diameter 76 mm

✓ Certificate:

Test certificate according to EN 10 204 - 2.2



7.3.2

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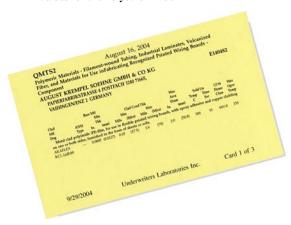


Technical data for AKAFLEX® PEICL 2-35/50 HT 35 μm copper foil / 50 μm polyetherimide film

Laminate properties	Test method IPC-TM 650	IPC-4202/2 (for PEI film)	Typical values			
Peel strength						
- as delivered	2.4.9		> 2	N/mm	> 11.4	lb/in
- after solder dip	2.4.9		DBD	N/mm	DBD	lb/in
- after temperature cycling	2.4.9		DBD	N/mm	DBD	lb/in
Tensile strength*	2.4.19	> 103	110	N/mm²	>16.0x10 ³	psi
Failure strain*	2.4.19	> 35	105	%	> 105	%
Initial tear strength*	2.4.16	> 5	> 5.2	N	> 18.7	OZ
Flexural strength	2.4.3 Equipment per 2.4.3.1 Test mandrel d=2 mm		DBD	cycles	DBD	cycles
Dimensional stability, MD/TD (after etching and 30 min. at 150 °C)	2.2.4 Method C	-	0.1/0.05	%	0.1/0.05	%
Solder-bath stability at 288 °C	2.4.13 B		180	sec	180	sec
Dielectric strength*	ASTM D 149	> 78.74	180	V/µm	4600	V/mil
Flame retardance*	UL 94	VTM-0	VTM-0		VTM-0	

N/A = Not Applicable
DBD = Data Being Developed

* = Values for the Polyetherimide film



7.3.3